

# VS-47CTQ020SPbF, VS-47CTQ020-1PbF

# Vishay Semiconductors

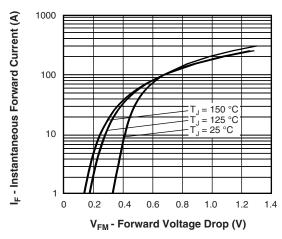
<b>ELECTRICAL SPECIFICATION</b>	IS				
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
		20 A	T 05 °C	0.45	
		40 A	T <sub>J</sub> = 25 °C	0.51	
Manifestor for conditional disease disease in an In-	V (1)	20 A	T 105 %	0.34	.,
Maximum forward voltage drop per leg	V <sub>FM</sub> <sup>(1)</sup>	40 A	T <sub>J</sub> = 125 °C	0.44	V
		20 A	T 150 00	0.31	1
		40 A	T <sub>J</sub> = 150 °C	0.42	
		T <sub>J</sub> = 125 °C	V <sub>R</sub> = 5 V	60	
			V <sub>R</sub> = 3.3 V	45	mA
Maximum reverse leakage current per leg	I <sub>RM</sub> <sup>(1)</sup>	T <sub>J</sub> = 150 °C	V <sub>R</sub> = 10 V	306	
current per log		T <sub>J</sub> = 25 °C	V Balady	3	
		T <sub>J</sub> = 125 °C	V <sub>R</sub> = Rated V <sub>R</sub>	310	
Threshold voltage	V <sub>F(TO)</sub>	$T_J = T_J$ maximum	0.188	V	
Forward slope resistance	r <sub>t</sub>		5.9	mΩ	
Maximum junction capacitance per leg	C <sub>T</sub>	V <sub>R</sub> = 5 V <sub>DC</sub> (test signa	al range 100 kHz to 1 MHz), 25 °C	3000	pF
Typical series inductance per leg	L <sub>S</sub>	Measured lead to lea	d 5 mm from package body	5.5	nH
Maximum voltage rate of change	dV/dt	Rated V <sub>R</sub>		10 000	V/µs

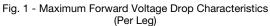
#### Note

 $<sup>^{(1)}\,</sup>$  Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHA	NICAL SP	ECIFICAT	IONS		
PARAMETER	SYMBOL TEST CONDITIONS VALUES		VALUES	UNITS	
Maximum junction and stora temperature range	ge	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +150	°C
Maximum thermal resistance junction to case per leg	<b>)</b> ,	В	DC eneration	1.5	
Maximum thermal resistance, junction to case per package		- R <sub>thJC</sub>	DC operation	0.75	°C/W
Typical thermal resistance, case to heatsink		R <sub>thCS</sub>	Mounting surface, smooth and greased	ed 0.50	
Approximate weight				2	g
Approximate weight				0.07	oz.
Maunting toyour	minimum			6 (5)	kgf · cm
Mounting torque	maximum			12 (10)	(lbf · in)
Maybing daying			Case style TO-263AB (D2PAK)	47CTQ0	208
Marking device			Case style TO-262AA	62AA 47CTQ0	

# Vishay Semiconductors





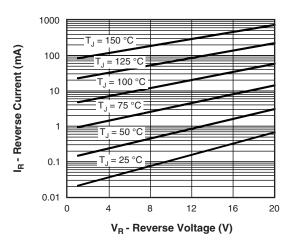


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

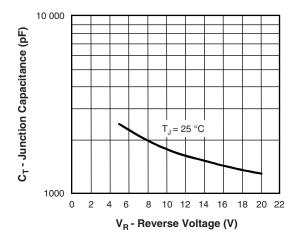


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

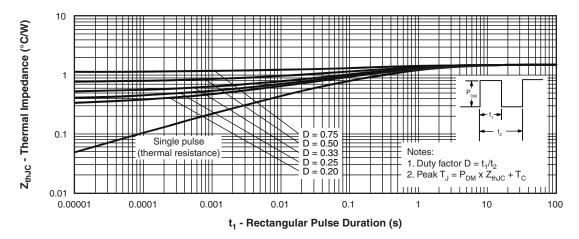


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)

www.vishay.com

# Vishay Semiconductors

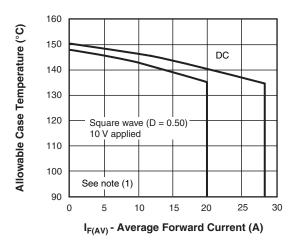


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

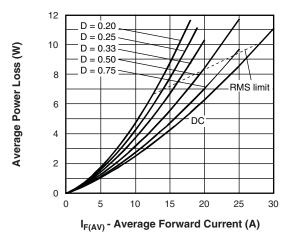


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

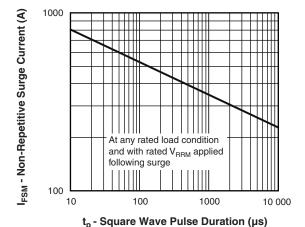


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

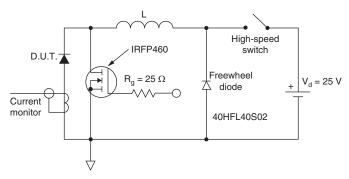


Fig. 8 - Unclamped Inductive Test Circuit

## Note

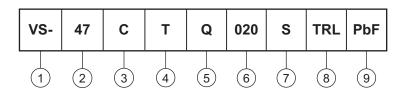
 $^{(1)}$  Formula used:  $T_C = T_J$  - (Pd + Pd\_{REV}) x R<sub>thJC</sub>; Pd = Forward power loss =  $I_{F(AV)}$  x V<sub>FM</sub> at (I<sub>F(AV)</sub>/D) (see fig. 6); Pd\_{REV} = Inverse power loss = V<sub>R1</sub> x I<sub>R</sub> (1 - D); I<sub>R</sub> at V<sub>R1</sub> = 10 V

# VS-47CTQ020SPbF, VS-47CTQ020-1PbF

Vishay Semiconductors

## **ORDERING INFORMATION TABLE**

Device code



- 1 Vishay Semiconductors product
- 2 Current rating (40 A)
- 3 Circuit configuration: C = common cathode
- **4** T = TO-220
- 5 Schottky "Q" series
  - Voltage rating (020 = 20 V)
- 7 • S = D<sup>2</sup>PAK
  - -1 = TO-262
- 8 • None = tube (50 pieces)
  - TRL = tape and reel (left oriented for D<sup>2</sup>PAK only)
  - TRR = tape and reel (right oriented for D<sup>2</sup>PAK only)
- 9 PbF = lead (Pb)-free

ORDERING INFORMATI	RDERING INFORMATION (Example)					
PREFERRED P/N	QUANTITY PER REEL	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-42CTQ020SPBF	50	1000	Antistatic plastic tubes			
VS-42CTQ020STRRPBF	800	800	13" diameter plastic tape and reel			
VS-42CTQ020STRLPBF	800	800	13" diameter plastic tape and reel			
VS-42CTQ020-1PBF	50	1000	Antistatic plastic tubes			

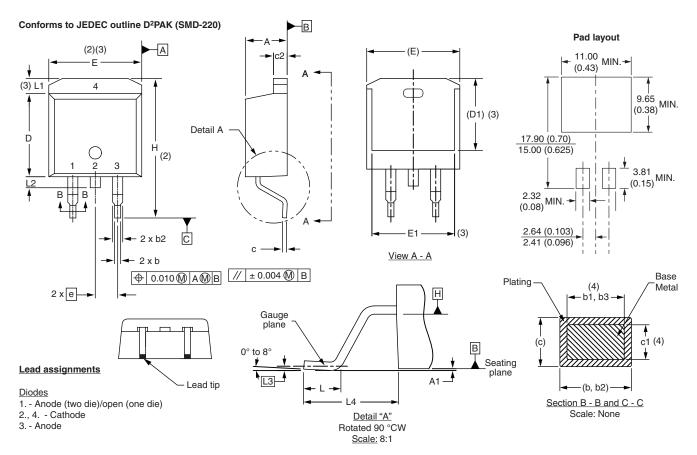
	LINKS TO RELATED DOCUMENTS				
Dimensions	TO-263AB (D <sup>2</sup> PAK)	www.vishay.com/doc?95046			
Dimensions	TO-262AA	www.vishay.com/doc?95419			
Part marking information		www.vishay.com/doc?95008			
Packaging information		www.vishay.com/doc?95032			



## Vishay Semiconductors

# **D<sup>2</sup>PAK, TO-262**

## **DIMENSIONS - D<sup>2</sup>PAK** in millimeters and inches



	1		1		
SYMBOL	MILLIMETERS		INCHES		NOTES
STIMBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STIVIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- $^{(3)}\,$  Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch

(7) Outline conforms to JEDEC outline TO-263AB

Document Number: 95014 Revision: 31-Mar-09

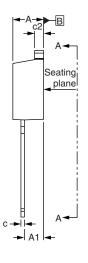
# Vishay Semiconductors

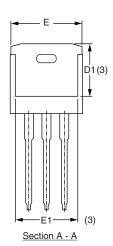
D<sup>2</sup>PAK, TO-262



## **DIMENSIONS - TO-262** in millimeters and inches

# 





**⊕** 0.010 **M** A **M** B

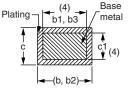
## Lead assignments



#### **Diodes**

1. - Anode (two die)/open (one die) 2., 4. - Cathode

3. - Anode



Section B - B and C - C Scale: None

SYMBOL	MILLIM	IETERS	INC	NOTES	
	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100	D BSC	
L	13.46	14.10	0.530	0.555	
L1	=	1.65	-	0.065	3
L2	3.56	3.71	0.140	0.146	

## Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches

(6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline

# **Legal Disclaimer Notice**



Vishay

## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2017 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED